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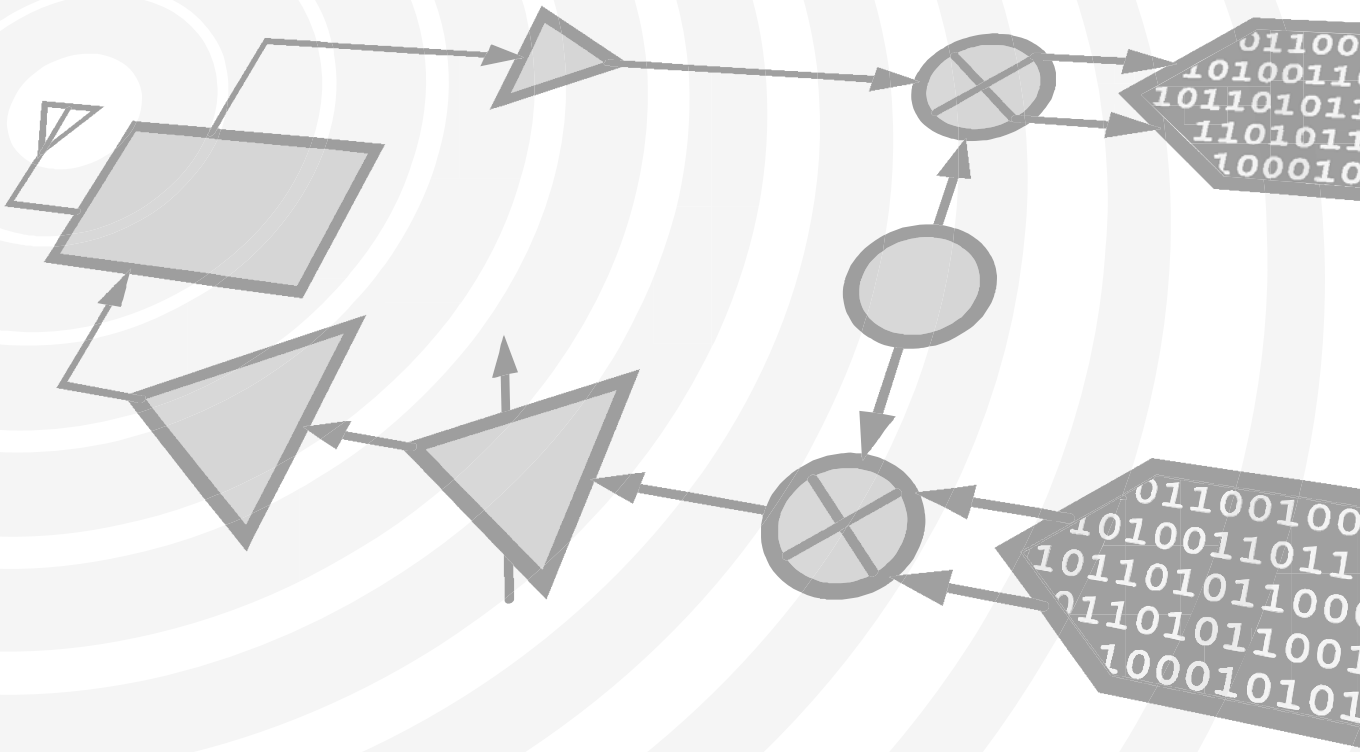

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HMC813LC4B

SUCCESSIVE DETECTION LOG VIDEO AMPLIFIER (SDLVA) WITH LIMITED RF OUTPUT, 1 - 20 GHz

Typical Applications

The HMC813LC4B is ideal for:

- EW, ELINT & IFM Receivers
- DF Radar Systems
- ECM Systems
- Broadband Test & Measurement
- Power Measurement & Control Circuits
- Military & Space Applications

Features

High Logging Range: 55 dB

Frequency Flatness: ±1.5 dB

Saturated Output Power: -7 dBm

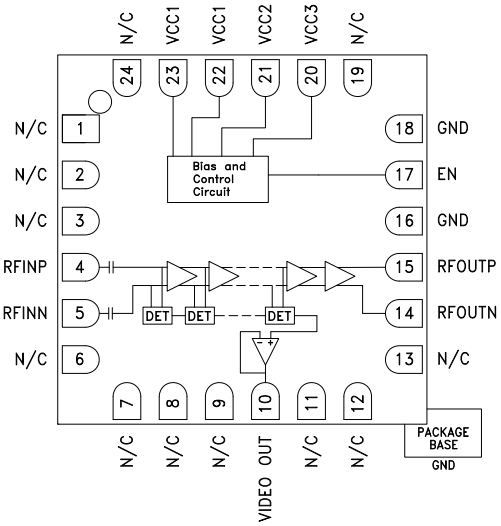
Fast Rise/Fall Times: 5/10 ns

Single Positive Supply: +3.3V

ESD Sensitivity (HBM): Class 1A

24 Lead 4x4 mm SMT Package: 16 mm²

Functional Diagram



General Description

The HMC813LC4B is a Successive Detection Log Video Amplifier (SDLVA) with a limited RF output which operates from 1 to 20 GHz. The HMC813LC4B provides a logging range of 55 dB. This device offers typical fast rise/fall times of 5/10 ns. The HMC813LC4B log video output slope is typically 15 mV/dB. Maximum recovery times are less than 15 ns. Ideal for high speed channelized receiver applications, the HMC813LC4B operates from a single +3.3 V supply, and consumes only 153 mA. The HMC813LC4B is available in a highly compact 4x4 mm SMT ceramic package and is ideal for high speed channelized receiver applications.

Electrical Specifications, T_A = +25 °C, Vcc1 = Vcc2 = Vcc3 = 3.3V [1]

Parameter	Conditions	Typ.	Units
Input Frequency Range[2]		1 - 20	GHz
Frequency Flatness (Video out)	Pin= -25 dBm	±1.5	dB
Log Linearity	Pin= -40 dBm to +0 dBm	±1	dB
Log Linearity over Temperature	-55 to +85° C, Pin= -20 dBm	±0.5	dB
Minimum Logging Range	to ±3 dB error @ 18 GHz	-53	dBm
Maximum Logging Range	to ±3 dB error @ 18 GHz	7	dBm
Saturated Output Power, Psat		-7	dBm
Saturated Output Power Flatness		±1.5	dB
RF Input Return Loss		8	dB
RF Output Return Loss		18	dB
Log Video Minimum Output Voltage		0.9	V
Log Video Maximum Output Voltage		1.73	V
Log Video Output Rise Time	Pin = 0 dBm, 10% to 90%	5	ns
Log Video Output Fall Time	Pin = 0 dBm, 90% to 10%	10	ns

[1] Electrical specifications and performance plots are given for single-ended operation.
[2] Video output load should be 1K Ohm or higher.

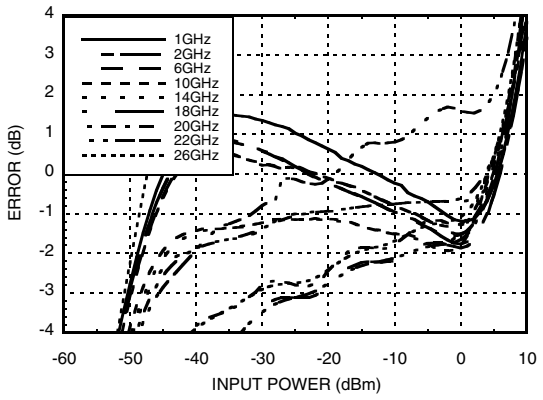
SUCCESSIVE DETECTION LOG VIDEO AMPLIFIER (SDLVA) WITH LIMITED RF OUTPUT, 1 - 20 GHz

Electrical Specifications, (continued) [1]

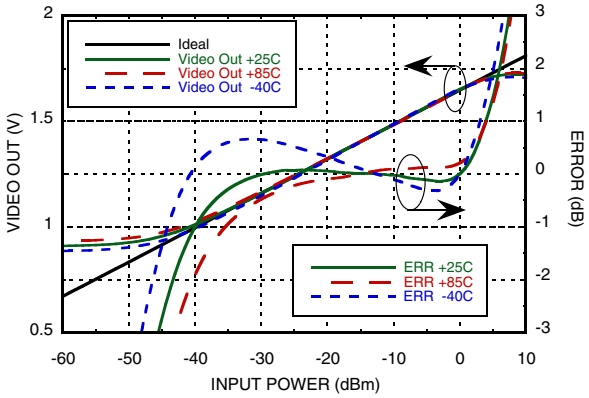
Parameter	Conditions	Typ.	Units
Log Video Recovery Time	-40 dBm to 0 dBm	15	ns
Log Video Output Slope		15	mV/dB
Log Video Output Slope Variation over Temperature	@ 10 GHz	10	µV/dB°C
Log Video Propagation Delay		15	ns
Supply Current (Idc)		153	mA

[1] Electrical specifications and performance plots are given for single-ended operation

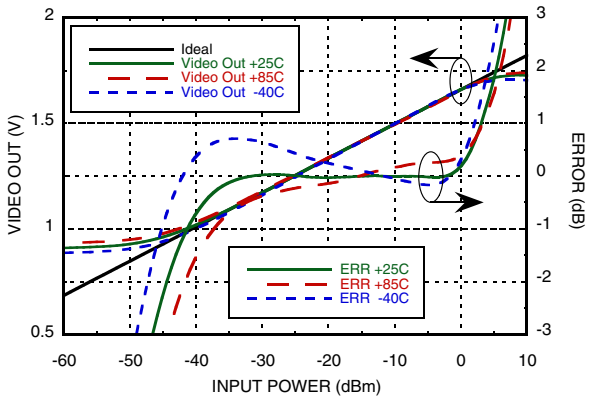
Error Flatness vs. Input Power Over Frequency [1]



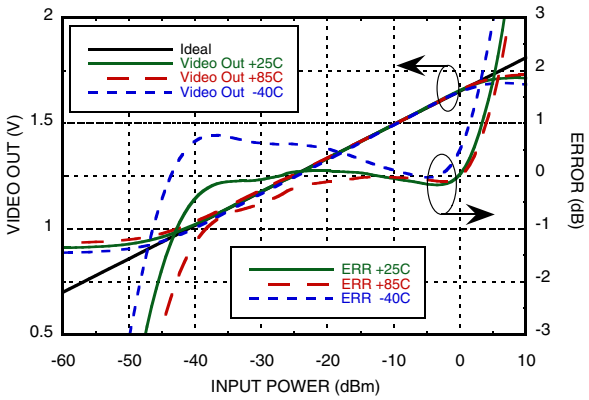
VIDEO OUT & Error vs. Input Power, Fin = 1 GHz [1]



VIDEO OUT & Error vs. Input Power, Fin = 2 GHz [1]



VIDEO OUT & Error vs. Input Power, Fin = 6 GHz [1]



[1] Electrical specs and performance plots are given for single-ended operation

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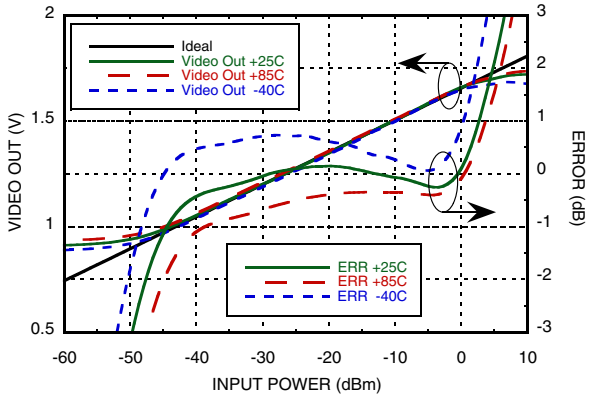
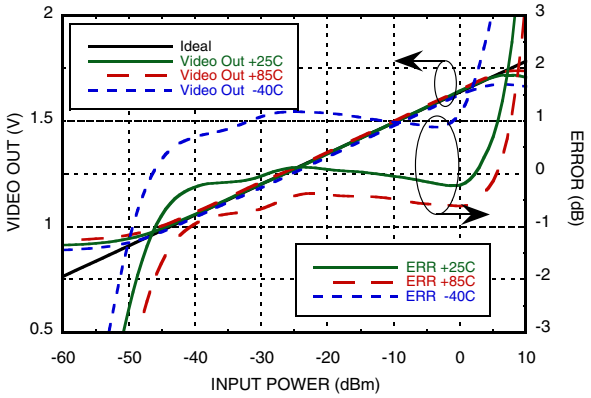
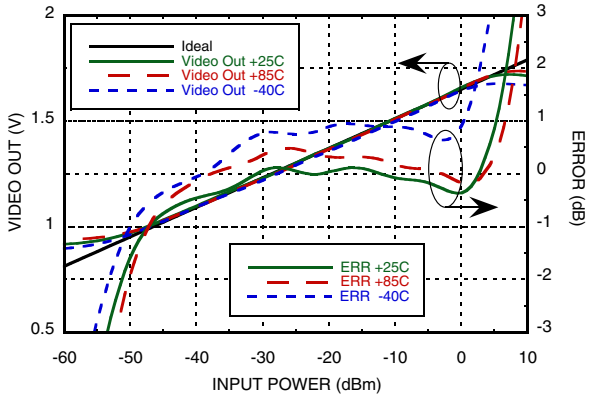
VIDEO OUT & Error vs. Input Power, Fin = 10 GHz [1]



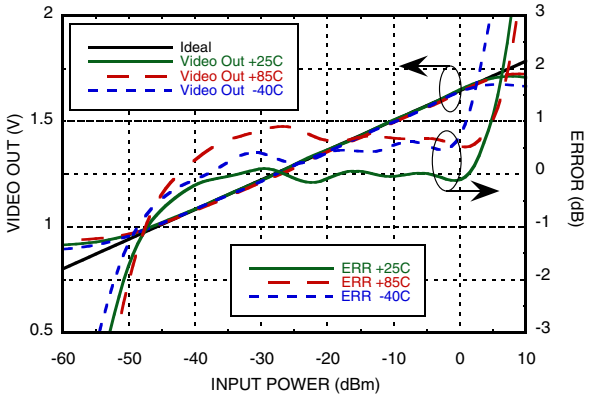
VIDEO OUT & Error vs. Input Power, Fin = 14 GHz [1]



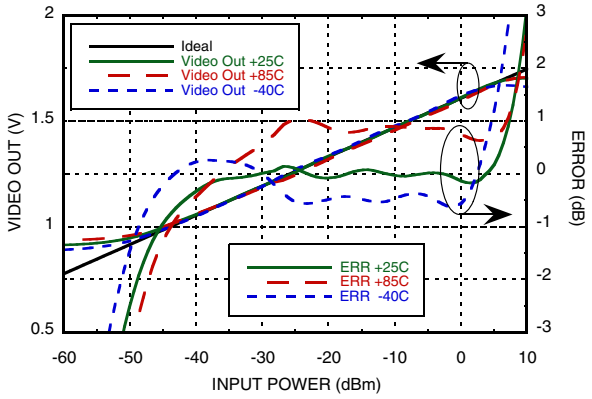
VIDEO OUT vs. Error vs. Input Power, Fin = 18 GHz [1]



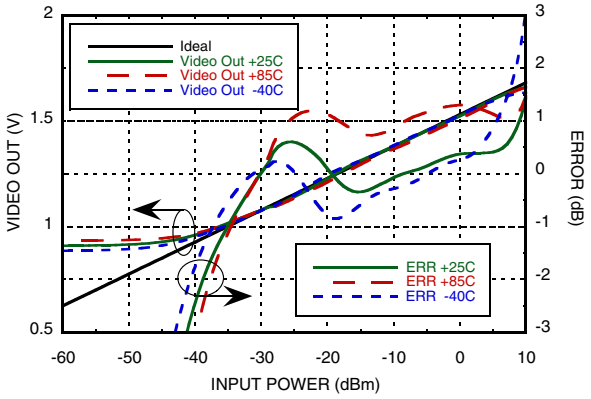
VIDEO OUT & Error vs. Input Power, Fin = 20 GHz [1]



VIDEO OUT & Error vs. Input Power, Fin = 22 GHz [1]



VIDEO OUT & Error vs. Input Power, Fin = 26 GHz [1]



[1] Electrical specs and performance plots are given for single-ended operation

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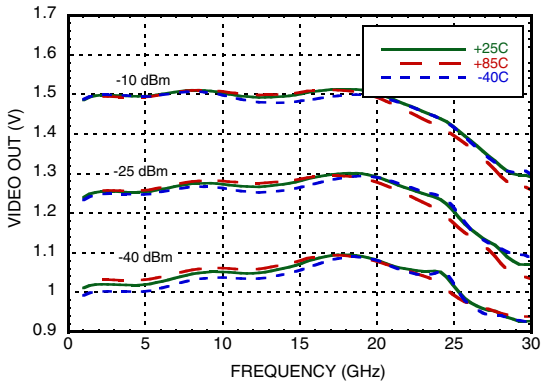
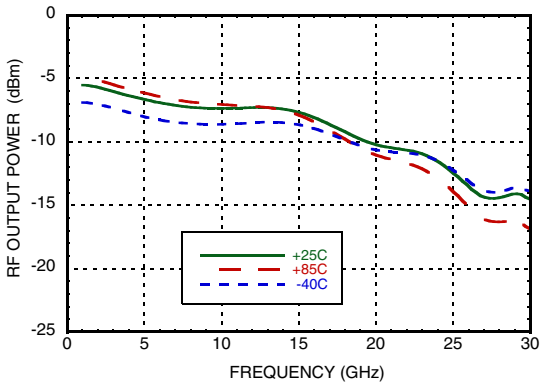
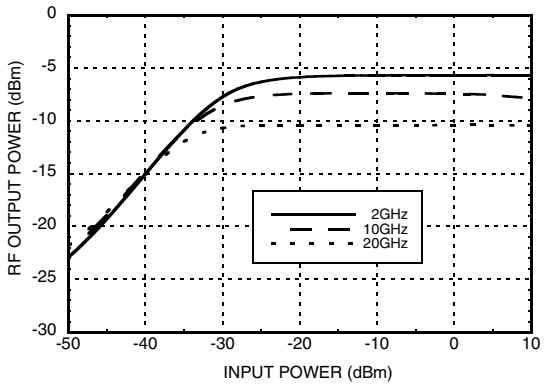
VIDEO OUT vs. Frequency Over Input Power & Temperature [1]



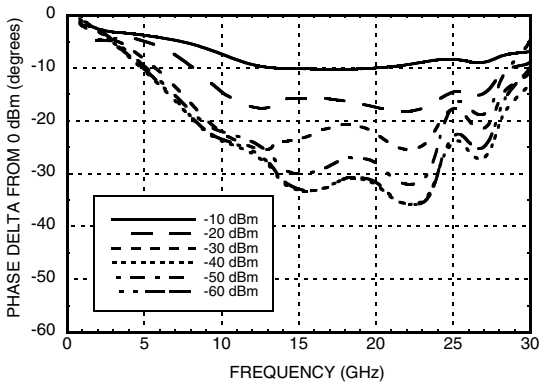
Saturated RF Output Power vs. Frequency Over Temperature @ Pin = -10 dBm [1]



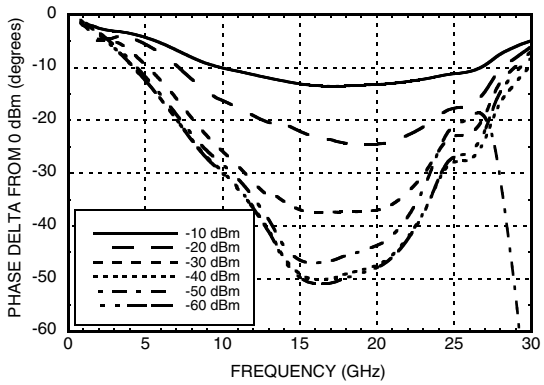
RF Output Power vs. Input Power Over Frequency [1]



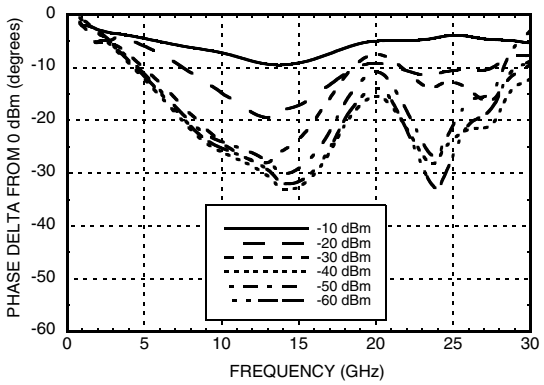
Phase Linearity over Frequency @ 25 C Temperature [1]



Phase Linearity over Frequency @ 85 C Temperature [1]



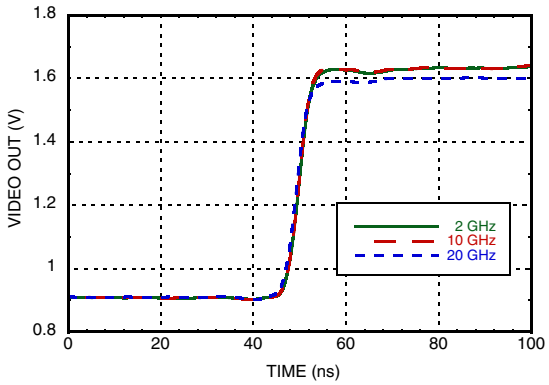
Phase Linearity over Frequency @ -40 C Temperature [1]



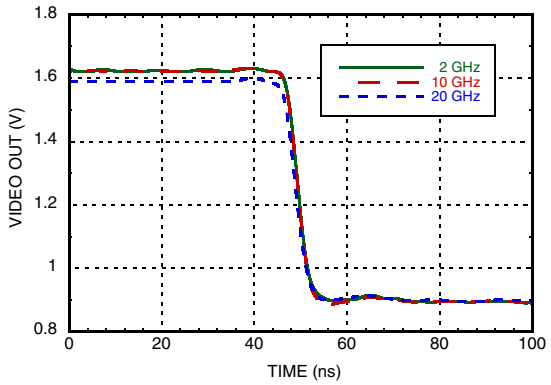
[1] Electrical specs and performance plots are given for single-ended operation

SUCCESSIVE DETECTION LOG VIDEO AMPLIFIER (SDLVA) WITH LIMITED RF OUTPUT, 1 - 20 GHz

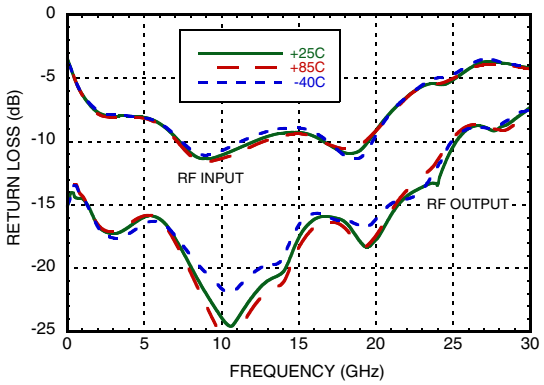
Rise Time for Various Frequencies @ Pin = 0 dBm [1]



Fall Time for Various Frequencies @ Pin = 0 dBm [1]



Return Loss vs. Frequency Over Temperature [1]



[1] Electrical specs and performance plots are given for single-ended operation

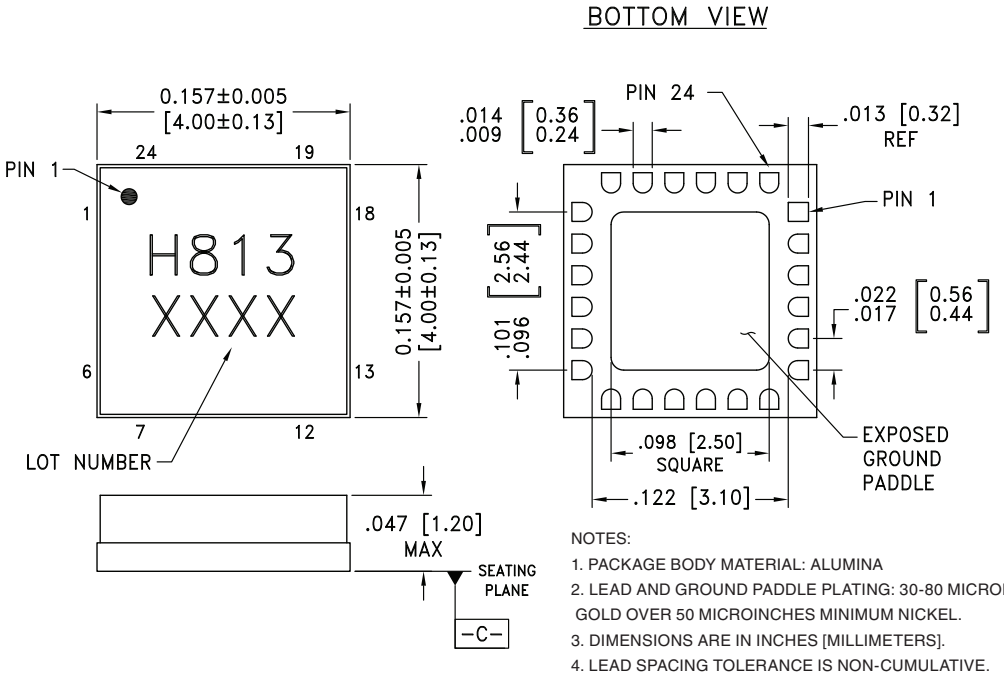
SUCCESSIVE DETECTION LOG VIDEO AMPLIFIER (SDLVA) WITH LIMITED RF OUTPUT, 1 - 20 GHz

Absolute Maximum Ratings

Vcc1, Vcc2, Vcc3, Vcc4	+3.6V
ENBL	+3.6V
RF Input Power	+15 dBm
Channel Temperature	125 °C
Continuous Pdiss (T=85°C) Derate 12.63 mW/°C above 85°C	0.51 W
Thermal Resistance (Channel to die bottom)	79.20 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C
ESD Sensitivity (HBM)	Class 1A

ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



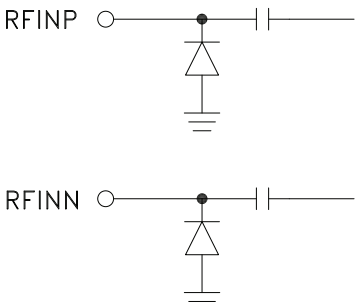
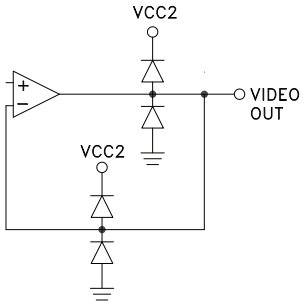
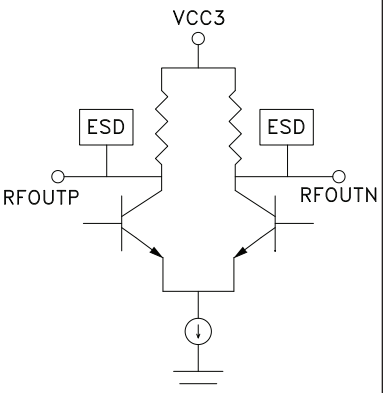
NOTES:
1. PACKAGE BODY MATERIAL: ALUMINA
2. LEAD AND GROUND PADDLE PLATING: 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC813LC4B	Alumina, White	Gold over Nickel	MSL3 [1]	H813 XXXX

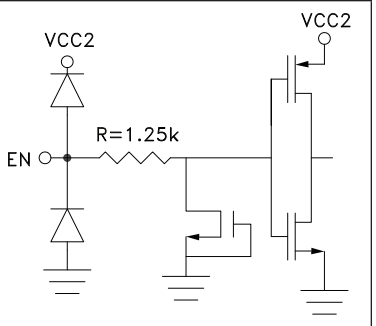
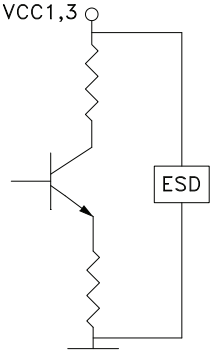
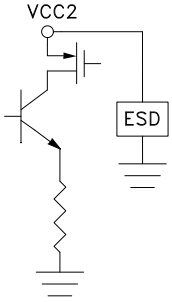
[1] Max peak reflow temperature of 260 °C
[2] 4-Digit lot number XXXX

Pin Descriptions

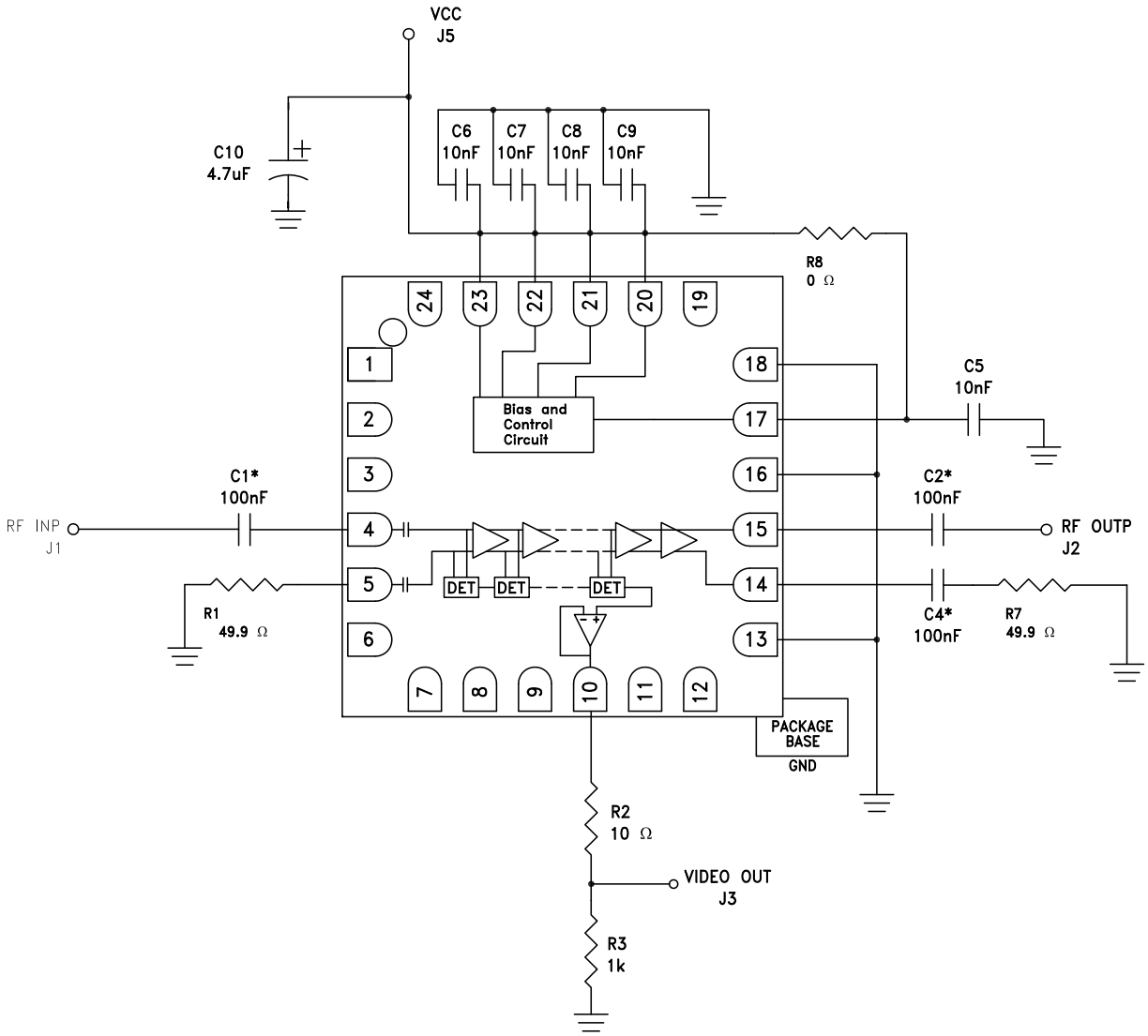
Pin Number	Function	Description	Interface Schematic
1-3, 6-9, 11-13, 19, 24	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
4, 5	RFINP, RFINN	RF Input pins. Connect RF to RFINP, and AC couple RFINN to ground via 50 Ohm for single ended operation.	
10	VIDEO OUT	Video out load should be at least 1K Ohm or higher.	
14, 15	RFOUTN, RFOUTP	RF Output pins. Connect RF to RFOUTP, and AC couple RFOUTN to ground via 50 Ohm for single ended operation	
16, 18	GND	These pins and the exposed package bottom must be connected to a high quality RF/DC ground.	

SUCCESSIVE DETECTION LOG VIDEO AMPLIFIER (SDLVA) WITH LIMITED RF OUTPUT, 1 - 20 GHz

Pad Descriptions *(Continued)*

Pin Number	Function	Description	Interface Schematic
17	EN	Enable pin, connected to supply voltage for normal operation. Total supply current reduced to less than 3mA when EN is set to 0V.	
20	VCC3	Bias supply. Connect supply voltage to these pins with appropriate filtering. See application circuit. To ensure proper start-up supply rise time should be faster than 100usec	
22, 23	VCC1		
21	VCC2	Bias supply. Connect supply voltage to this pin with appropriate filtering. See application circuit. To ensure proper start-up supply rise time should be faster than 100usec	

Application Circuit

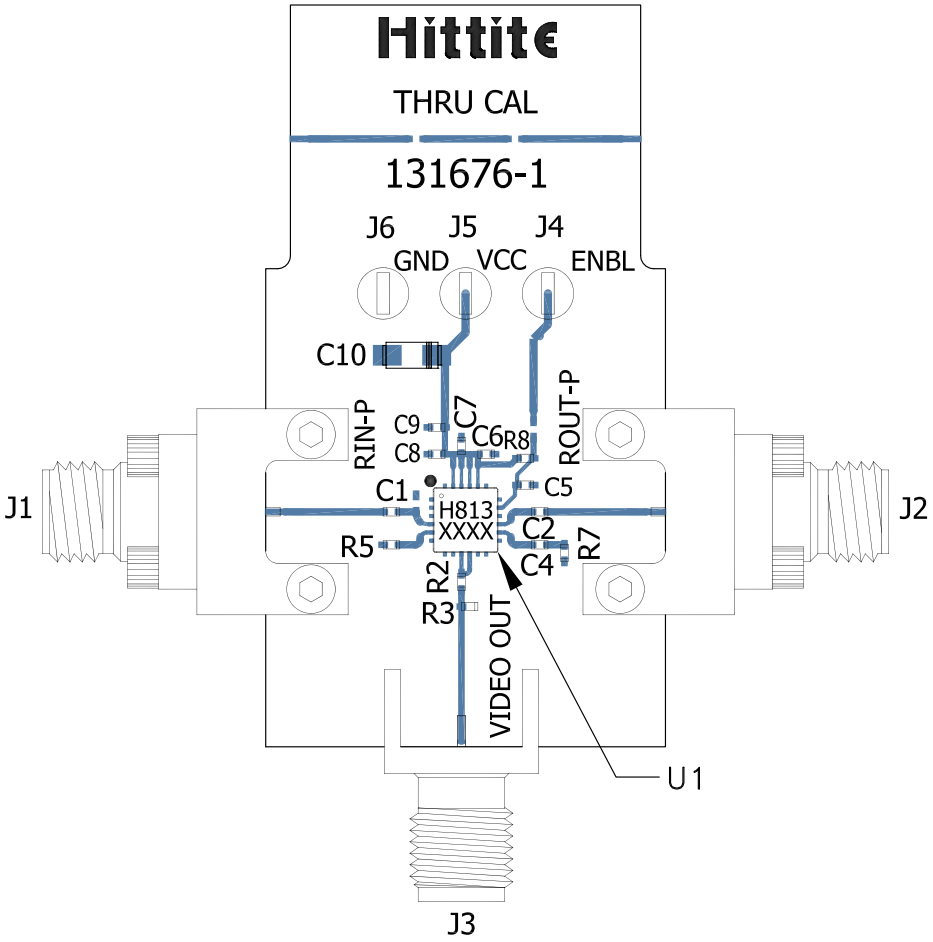


*C1, C2 and C4 are ultra-wideband capacitors.

Note: Video output load should be 1K Ohm or higher.

SUCCESSIVE DETECTION LOG VIDEO AMPLIFIER (SDLVA) WITH LIMITED RF OUTPUT, 1 - 20 GHz

Evaluation PCB



List of Materials for Evaluation PCB 131679 [1]

Item	Description
J1, J2	K-Type Connector
J3	SMA Connector
J4 - J6	DC Pins
C1, C2, C4	100 nF Ultra-Wideband Capacitor, 0402 Pkg. ATC ATC545L104KW16T
C5 - C9	10 nF Capacitor, 0402 Pkg.
C10	4.7 µF Tantalum Capacitor, CASE A Pkg.
R2	10 Ohm Resistor, 0402 Pkg.
R3	1k Ohm Resistor, 0402 Pkg.
R5, R7	49.9 Ohm Resistor, 0402 Pkg.
R8	0 Ohm Resistor, 0402 Pkg.
U1	HMC813LC4B SDLVA

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon 25 FR

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

Mouser Electronics

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